

Data Sheet

Description

The FMET-23015 is a 150 V, 30 A Schottky diode with a trench structure, allowing improvements in V_F and I_R characteristics. These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

Features

 V_{RSM} 	150 V
• I _{F(AV)}	30 A
• $V_F (I_F = 15 \text{ A})$	0.90 V typ.

• RoHS Compliant

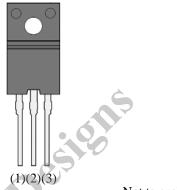
Applications

High speed switching applications such as:

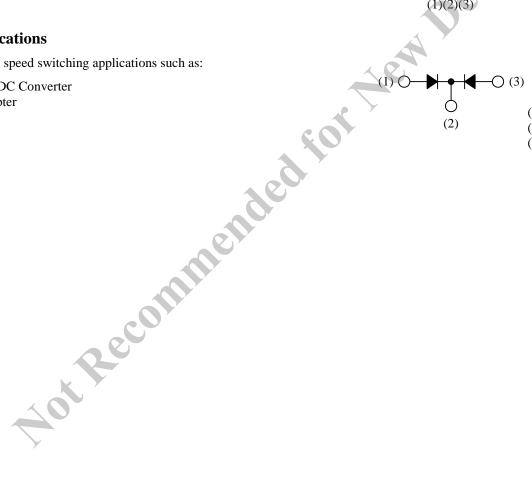
- DC-DC Converter
- Adapter

Package

TO220F-3L



Not to scale



- (1) Anode
- (2) Cathode
- (3) Anode

FMET-23015

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage ⁽¹⁾	V_{RSM}	150	V	
Repetitive Reverse Voltage ⁽¹⁾	V_{RM}	150	V	
Average Forward Current ⁽²⁾	I _{F(AV)}	30	A	See Figure 1 and Figure 2
Surge Forward Current ⁽¹⁾	I_{FSM}	150	A	Half cycle sine wave, positive side, 10 ms, 1 shot
I ² t Limiting Value ⁽¹⁾	I ² t	112.5	A^2s	
Junction Temperature	T_{J}	-40 to 150	°C	.5
Storage Temperature	T_{STG}	-40 to 150	°C	

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Uniess otherwise specified, $T_A = 23$	•	1		/		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop ⁽¹⁾	V_{F}	I _F = 15 A	V _	0.90	0.98	V
Reverse Leakage Current ⁽¹⁾	I_R	$V_R = V_{RM}$	_	_	150	μΑ
Reverse Leakage Current under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_	_	75	mA
Thermal Resistance ⁽³⁾	$R_{\text{th}(J\text{-}C)}$			_	4.0	°C/W
Thermal Resistance (3)						

⁽¹⁾ Specifies a value per chip; the FMET-23015 consists of two chips.
⁽²⁾ Specifies a value of the two chips configuring the product; a value per chip is 15 A.

 $^{^{(3)}}R_{th (J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

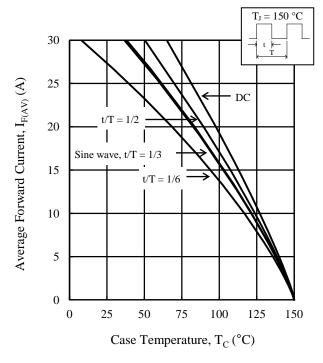


Figure 1. $T_C \text{ vs. } I_{F(AV)} \text{ Typical Characteristics}$ $(V_R = 0 \text{ V})$

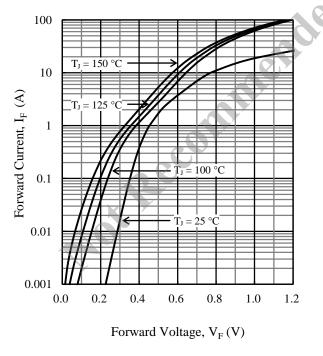


Figure 3. V_F vs. I_F Typical Characteristics

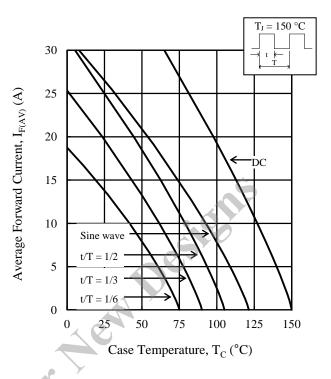


Figure 2. T_C vs. $I_{F(AV)}$ Typical Characteristics $(V_R = 150 \ V)$

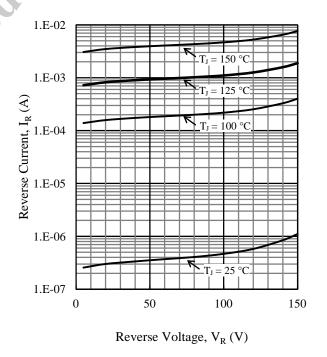
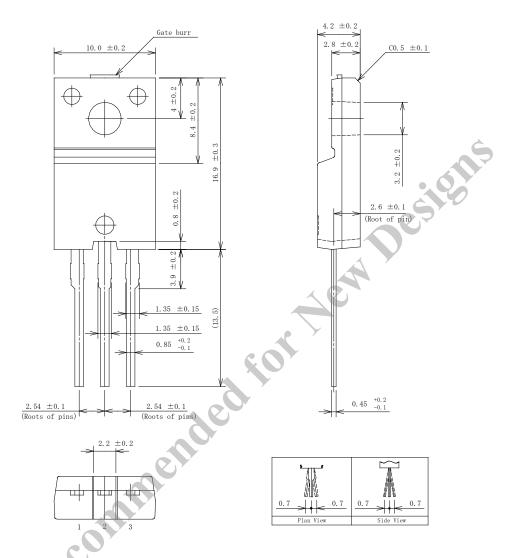


Figure 4. V_R vs. I_R Typical Characteristics

Physical Dimensions

• TO220F



NOTES:

- Dimensions in millimeters
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:

Flow: $260 \pm 5 \, {}^{\circ}\text{C} / 10 \pm 1 \, \text{s}, 2 \, \text{times}$

Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

Recommended screw torque for TO220F: 0.490 N·m to 0.686 N·m (5 kgf·cm to 7 kgf·cm)

Marking Diagram

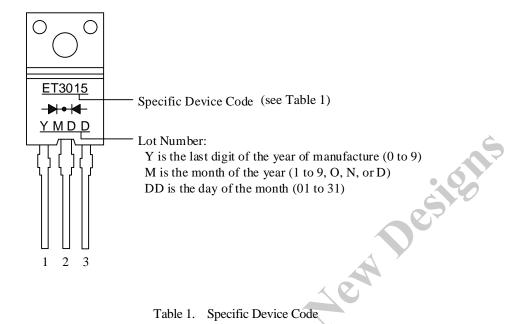


Table 1. Specific Device Code

	Specific Device Code	Part Number
	ET3015	FMET-23015
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